

200 mA 36 V Input Ultra Low Supply Current VR for Automotive Applications

No. EC-332-190109

OUTLINE

The R1524x is an ultra-low supply current voltage regulator featuring 200 mA output current and 36 V input voltage. This device consists of an Output Short-circuit Protection Circuit, an Over-current Protection Circuit, and a Thermal Shutdown Circuit in addition to the basic regulator circuits. The operating temperature range is between -40°C to 125°C , and the maximum input voltage is 36 V. All these features allow this device to become an ideal power source for car accessories and ECUs.

The output voltages are internally fixed at either of the following: 1.8 V, 2.5 V, 2.8 V, 3.0 V, 3.3 V, 3.4 V, 5.0 V, 5.5 V, 6.0 V, 6.4 V, 7.5 V, 8.0 V, 8.5 V and 9.0 V. The output voltage accuracy is $\pm 0.6\%$.

The packages for this device range from high-density mounting to ultra high wattage. The R1524x is offered in four packages; a 5-pin SOT-23-5, a 5-pin SOT-89-5, and a 6-pin HSOP-6J, and an 8-pin HSOP-8E package.

FEATURES

- Input Voltage Range (Maximum Rating) 3.5 V to 36 V (50 V)
- Operating Temperature Range -40°C to 125°C
- Supply Current..... Typ. 2.2 μA
- Standby Current..... Typ. 0.1 μA
- Dropout Voltage Typ. 0.6 V ($I_{\text{OUT}} = 200 \text{ mA}$, $V_{\text{OUT}} = 5.0 \text{ V}$)
- Output Voltage Range 1.8 V / 2.5 V / 2.8 V / 3.0 V / 3.3 V / 3.4 V / 5.0 V /
5.5 V / 6.0 V / 6.4 V / 7.5 V / 8.0 V / 8.5 V / 9.0 V
*Contact Ricoh sales representatives for other voltages.
- Output Voltage Accuracy..... $\pm 0.6\%$ ($T_a = 25^{\circ}\text{C}$)
- Output Voltage Temperature-Drift Coefficient Typ. $\pm 60 \text{ ppm}/^{\circ}\text{C}$
- Line Regulation..... Typ. 0.01%/V ($V_{\text{SET}} + 1 \text{ V} \leq V_{\text{IN}} \leq 36 \text{ V}$)
- Built-in Output Short-circuit Protection Circuit Typ. 80 mA
- Built-in Over-current Protection Circuit Typ. 350 mA
- Built-in Thermal Shutdown Circuit Thermal Shutdown Temperature: Typ. 160°C
- Ceramic capacitors are recommended
to be used with this device $C_{\text{OUT}} = 0.1 \mu\text{F}$ or more
- Packages SOT-23-5, SOT-89-5, HSOP-6J, HSOP-8E

APPLICATIONS

- Power source for accessories such as car audios, car navigation systems, and ETC systems
- Power source for ECUs such as EV inverter and battery charge control unit

R1524x

No. EC-332-190109

SELECTION GUIDE

The set output voltage, the package type, and the quality class are user-selectable.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1524NxxxB-TR-#E	SOT-23-5	3,000 pcs	Yes	Yes
R1524HxxxB-T1-#E	SOT-89-5	1,000 pcs	Yes	Yes
R1524SxxxB-E2-#E	HSOP-6J	1,000 pcs	Yes	Yes
R1524SxxxH-E2-#E	HSOP-8E	1,000 pcs	Yes	Yes

xxx: Specify the set output voltage (V_{SET})

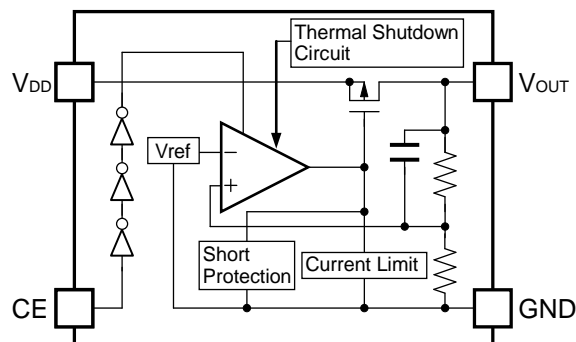
1.8 V (018) / 2.5 V (025) / 2.8 V (028) / 3.0 V (030) / 3.3 V (033) / 3.4 V (034) / 5.0 V (050) /
5.5 V (055) / 6.0 V (060) / 6.4 V (064) / 7.5 V (075) / 8.0 V (080) / 8.5 V (085) / 9.0 V (090)

*Contact Ricoh sales representatives for other voltages.

: Quality Class

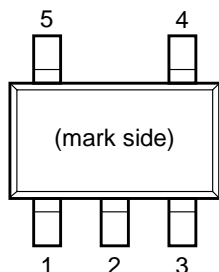
#	Operating Temperature Range	Test Temperature
A	-40°C to 125°C	25°C, High
K	-40°C to 125°C	Low, 25°C, High

BLOCK DIAGRAM

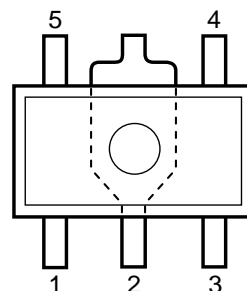


R1524x Block Diagram

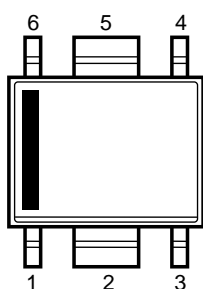
PIN DESCRIPTIONS



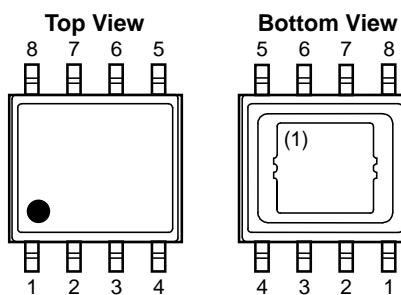
SOT-23-5 Pin Configuration



SOT-89-5 Pin Configuration



HSOP-6J Pin Configuration



HSOP-8E Pin Configuration

SOT-23-5 Pin Descriptions

Pin No.	Symbol	Description
1	GND ⁽²⁾	Ground Pin
2	GND ⁽²⁾	Ground Pin
3	CE	Chip Enable Pin (Active-high)
4	V _{OUT}	Output Pin
5	V _{DD}	Input Pin

SOT-89-5 Pin Descriptions

Pin No.	Symbol	Description
1	V _{OUT}	Output Pin
2	GND ⁽²⁾	Ground Pin
3	CE	Chip Enable Pin (Active-high)
4	GND ⁽²⁾	Ground Pin
5	V _{DD}	Input Pin

⁽¹⁾ The tab on the bottom of the package enhances thermal performance and is electrically connected to GND (substrate level). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left open.

⁽²⁾ The GND pin must be wired together when it is mounted on board.

R1524x

No. EC-332-190109

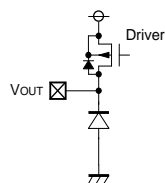
HSOP-6J Pin Descriptions

Pin No.	Symbol	Description
1	V_{OUT}	Output Pin
2	GND ⁽¹⁾	Ground Pin
3	CE	Chip Enable Pin (Active-high)
4	GND ⁽¹⁾	Ground Pin
5	GND ⁽¹⁾	Ground Pin
6	V_{DD}	Input Pin

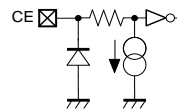
HSOP-8E Pin Descriptions

Pin No.	Symbol	Description
1	V_{OUT}	Output Pin
2	NC	No Connection
3	NC	No Connection
4	CE	Chip Enable Pin (Active-high)
5	GND	Ground Pin
6	NC	No Connection
7	NC	No Connection
8	V_{DD}	Input Pin

PIN EQUIVALENT CIRCUIT DIAGRAMS



V_{OUT} Pin



CE Pin

⁽¹⁾ The GND pin must be wired together when it is mounted on board.

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

Symbol	Item	Rating	Unit	
V_{IN}	Input Voltage	-0.3 to 50	V	
V_{IN}	Peak Input Voltage ⁽¹⁾	60	V	
V_{CE}	Input Voltage (CE Pin)	-0.3 to 50	V	
V_{OUT}	Output Voltage	-0.3 to $V_{IN} + 0.3 \leq 50$	V	
I_{OUT}	Output Current	300	mA	
P_D	Power Dissipation ⁽²⁾ (JEDEC STD.51-7 Test Land Pattern)	SOT-23-5	830	mW
		SOT-89-5	3200	
		HSOP-6J	3400	
		HSOP-8E	3600	
T_j	Junction Temperature Range	-40 to 150	°C	
T_{stg}	Storage Temperature Range	-55 to 150	°C	

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings are not assured.

RECOMMENDED OPERATING CONDITIONS

Recommended Operating Conditions

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	3.5 to 36	V
T_a	Operating Temperature Range	-40 to 125	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽¹⁾ Duration time: 200 ms

⁽²⁾ Refer to *POWER DISSIPATION* for detailed information.

R1524x

No. EC-332-190109

ELECTRICAL CHARACTERISTICS

$C_{IN} = C_{OUT} = 0.1 \mu\text{F}$, unless otherwise noted.

The specifications surrounded by \square are guaranteed by design engineering at $-40^\circ\text{C} \leq T_a \leq 125^\circ\text{C}$.

R1524x (-AE) Electrical Characteristics

($T_a = 25^\circ\text{C}$)

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
I_{SS}	Supply Current	$V_{IN} = 14 \text{ V}$ $I_{OUT} = 0 \text{ mA}$	$V_{SET} \leq 5.0 \text{ V}$		2.2	$\square 6.5$	μA
			$5.0 \text{ V} < V_{SET}$		2.5	$\square 6.8$	
$I_{standby}$	Standby Current	$V_{IN} = 36 \text{ V}, V_{CE} = 0 \text{ V}$			0.1	1.0	μA
V_{OUT}	Output Voltage	$V_{SET} + 1 \text{ V}^{(1)} \leq V_{IN} \leq 36 \text{ V}, I_{OUT} = 1 \text{ mA}$	$T_a = 25^\circ\text{C}$	$\times 0.994$		$\times 1.006$	V
			$-40^\circ\text{C} \leq T_a \leq 125^\circ\text{C}$	$\square \times 0.984$		$\square \times 1.016$	
$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$	Load Regulation	$V_{IN} = V_{SET} + 3.0 \text{ V}$ $1 \text{ mA} \leq I_{OUT} \leq 200 \text{ mA}$		Refer to the <i>Product-specific Electrical Characteristics</i>			
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	$V_{SET} + 1 \text{ V}^{(1)} \leq V_{IN} \leq 36 \text{ V}, I_{OUT} = 1 \text{ mA}$	$V_{SET} < 3.3 \text{ V}$	$\square -20$	5	$\square 20$	mV
			$3.3 \text{ V} \leq V_{SET}$	$\square -0.02$	0.01	$\square 0.02$	%/V
V_{DIF}	Dropout Voltage	$I_{OUT} = 200 \text{ mA}$		Refer to the <i>Product-specific Electrical Characteristics</i>			
I_{LIM}	Output Current Limit	$V_{IN} = V_{SET} + 3.0 \text{ V}$		$\square 220$	350	$\square 420$	mA
I_{SC}	Short Current Limit	$V_{IN} = 3.5 \text{ V}, V_{OUT} = 0 \text{ V}$		$\square 60$	80	$\square 110$	mA
V_{CEH}	CE Pin Input Voltage, high	$V_{IN} = V_{SET} + 1 \text{ V}^{(1)}$		$\square 2.0$		36	V
V_{CEL}	CE Pin Input Voltage, low	$V_{IN} = 36 \text{ V}$		0		$\square 1.0$	V
I_{PD}	CE Pull-down Current	$V_{IN} = 36 \text{ V}, V_{CE} = 2 \text{ V}$			0.2	$\square 0.6$	μA
T_{TSD}	Thermal Shutdown Detection Temperature	Junction Temperature			160		$^\circ\text{C}$
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature			135		$^\circ\text{C}$

All test items listed under Electrical Characteristics are done under the pulse load condition ($T_j \approx T_a = 25^\circ\text{C}$).

⁽¹⁾ $V_{SET} \leq 2.5 \text{ V}, V_{IN} = 3.5 \text{ V}$

The specifications surrounded by \square are guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$.

R1524x (-AE) Product-specific Electrical Characteristics

(Ta = 25°C)

Product Name	V _{OUT} (V) (Ta = 25°C)			V _{OUT} (V) (-40°C ≤ Ta ≤ 125°C)			ΔV _{OUT} /ΔI _{OUT} (mV)			V _{DIF} (V)	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	TYP.	MAX.
R1524x018x	1.7892	1.80	1.8108	\square 1.7712	1.80	\square 1.8288	\square -10	10	\square 40	1.6	\square 2.5
R1524x025x	2.4850	2.50	2.5150	\square 2.4600	2.50	\square 2.5400				1.2	\square 2.2
R1524x028x	2.7832	2.80	2.8168	\square 2.7552	2.80	\square 2.8448					
R1524x030x	2.9820	3.00	3.0180	\square 2.9520	3.00	\square 3.0480				0.8	\square 2.0
R1524x033x	3.2802	3.30	3.3198	\square 3.2472	3.30	\square 3.3528					
R1524x034x	3.3796	3.40	3.4204	\square 3.3456	3.40	\square 3.4544					
R1524x050x	4.9700	5.00	5.0300	\square 4.9200	5.00	\square 5.0800				\square -18	18
R1524x055x	5.4670	5.50	5.5330	\square 5.4120	5.50	\square 5.5880					
R1524x060x	5.9640	6.00	6.0360	\square 5.9040	6.00	\square 6.0960					
R1524x064x	6.3616	6.40	6.4384	\square 6.2976	6.40	\square 6.5024					
R1524x075x	7.4550	7.50	7.5450	\square 7.3800	7.50	\square 7.6200					
R1524x080x	7.9520	8.00	8.0480	\square 7.8720	8.00	\square 8.1280	0.5	\square 1.3			
R1524x085x	8.4490	8.50	8.5510	\square 8.3640	8.50	\square 8.6360					
R1524x090x	8.9460	9.00	9.0540	\square 8.8560	9.00	\square 9.1440					

R1524x

No. EC-332-190109

$C_{IN} = C_{OUT} = 0.1 \mu\text{F}$, unless otherwise noted.

R1524x (-KE) Electrical Characteristics

($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
I_{SS}	Supply Current	$V_{IN} = 14 \text{ V}$ $I_{OUT} = 0 \text{ mA}$	$V_{SET} \leq 5.0 \text{ V}$		2.2	6.5	μA
			$5.0 \text{ V} < V_{SET}$		2.5	6.8	
$I_{standby}$	Standby Current	$V_{IN} = 36 \text{ V}, V_{CE} = 0 \text{ V}$			0.1	1.0	μA
V_{OUT}	Output Voltage	$V_{SET} + 1 \text{ V}^{(1)} \leq V_{IN} \leq 36 \text{ V}, I_{OUT} = 1 \text{ mA}$	$T_a = 25^{\circ}\text{C}$	$\times 0.994$		$\times 1.006$	V
			$-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$	$\times 0.984$		$\times 1.016$	
$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$	Load Regulation	$V_{IN} = V_{SET} + 3.0 \text{ V}$ $1 \text{ mA} \leq I_{OUT} \leq 200 \text{ mA}$		Refer to the <i>Product-specific Electrical Characteristics</i>			
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	$V_{SET} + 1 \text{ V}^{(1)} \leq V_{IN} \leq 36 \text{ V}, I_{OUT} = 1 \text{ mA}$	$V_{SET} < 3.3 \text{ V}$	-20	5	20	mV
			$3.3 \text{ V} \leq V_{SET}$	-0.02	0.01	0.02	%/V
V_{DIF}	Dropout Voltage	$I_{OUT} = 200 \text{ mA}$		Refer to the <i>Product-specific Electrical Characteristics</i>			
I_{LIM}	Output Current Limit	$V_{IN} = V_{SET} + 3.0 \text{ V}$		220	350	420	mA
I_{SC}	Short Current Limit	$V_{IN} = 3.5 \text{ V}, V_{OUT} = 0 \text{ V}$		60	80	110	mA
V_{CEH}	CE Pin Input Voltage, high	$V_{IN} = V_{SET} + 1 \text{ V}^{(1)}$		2.0		36	V
V_{CEL}	CE Pin Input Voltage, low	$V_{IN} = 36 \text{ V}$		0		1.0	V
I_{PD}	CE Pull-down Current	$V_{IN} = 36 \text{ V}, V_{CE} = 2 \text{ V}$			0.2	0.6	μA
T_{TSD}	Thermal Shutdown Detection Temperature	Junction Temperature		150	160		$^{\circ}\text{C}$
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature		125	135		$^{\circ}\text{C}$

⁽¹⁾ $V_{SET} \leq 2.5 \text{ V}, V_{IN} = 3.5 \text{ V}$

R1524x (-KE) Product-specific Electrical Characteristics

(-40°C ≤ Ta ≤ 125°C)

Product Name	V _{OUT} (V) (Ta = 25°C)			V _{OUT} (V) (-40°C ≤ Ta ≤ 125°C)			ΔV _{OUT} /ΔI _{OUT} (mV)			V _{DIF} (V)	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	TYP.	MAX.
R1524x018x	1.7892	1.80	1.8108	1.7712	1.80	1.8288	-10	10	40	1.6	2.5
R1524x025x	2.4850	2.50	2.5150	2.4600	2.50	2.5400				1.2	2.2
R1524x028x	2.7832	2.80	2.8168	2.7552	2.80	2.8448					
R1524x030x	2.9820	3.00	3.0180	2.9520	3.00	3.0480				0.8	2.0
R1524x033x	3.2802	3.30	3.3198	3.2472	3.30	3.3528					
R1524x034x	3.3796	3.40	3.4204	3.3456	3.40	3.4544					
R1524x050x	4.9700	5.00	5.0300	4.9200	5.00	5.0800				-18	18
R1524x055x	5.4670	5.50	5.5330	5.4120	5.50	5.5880					
R1524x060x	5.9640	6.00	6.0360	5.9040	6.00	6.0960					
R1524x064x	6.3616	6.40	6.4384	6.2976	6.40	6.5024	0.5	1.3			
R1524x075x	7.4550	7.50	7.5450	7.3800	7.50	7.6200					
R1524x080x	7.9520	8.00	8.0480	7.8720	8.00	8.1280					
R1524x085x	8.4490	8.50	8.5510	8.3640	8.50	8.6360					
R1524x090x	8.9460	9.00	9.0540	8.8560	9.00	9.1440					

R1524x

No. EC-332-190109

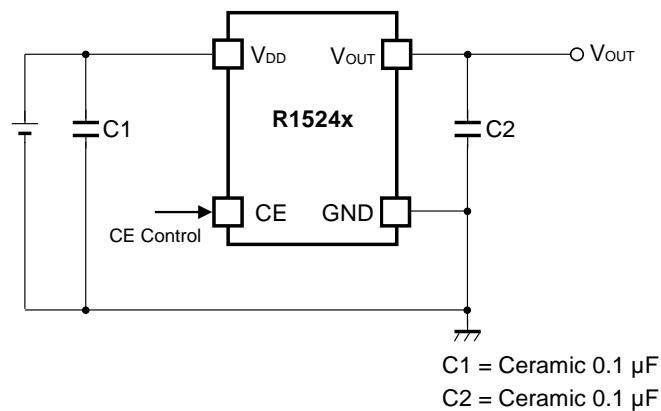
THEORY OF OPERATION

Thermal Shutdown

R1524x has a built-in thermal shutdown circuit, which stops the regulator operation if the junction temperature of this device increases to 160°C (Typ.) or higher. If the temperature drops to 135°C (Typ.) or lower, the regulator restarts the operation. Unless eliminating the overheating problem, the regulator turns on and off repeatedly and as a result, a pulse shaped output voltage is generated.

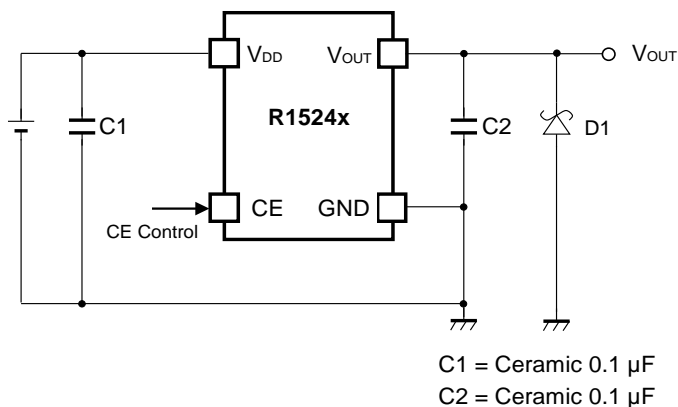
APPLICATION INFORMATION

TYPICAL APPLICATIONS



R1524x Typical Applications

TYPICAL APPLICATION FOR IC CHIP BREAKDOWN PREVENTION



R1524x Typical Application for IC Chip Breakdown Prevention

When a sudden surge of electrical current travels along the V_{OUT} pin and GND due to a short-circuit, electrical resonance of a circuit involving an output capacitor (C2) and a short circuit inductor generates a negative voltage and may damage the device or the load devices. Connecting a schottky diode (D1) between the V_{OUT} pin and GND has the effect of preventing damage to them.

TECHNICAL NOTES

Phase Compensation

In the R1524x, phase compensation is provided to secure stable operation even when the load current is varied. For this purpose, make sure to use 0.1 μF or more of a capacitor (C2).

In case of using a tantalum type capacitor and the ESR (Equivalent Series Resistance) value of the capacitor is large, the output might be unstable. Evaluate the circuit including consideration of frequency characteristics. Connect 0.1 μF or more of a capacitor (C1) between V_{DD} and GND, and as close as possible to the pins.

PCB Layout

For SOT-23-5 package type, wire the following GND pins together: No. 1 and No. 2

For SOT-89-5 package type, wire the following GND pins together: No. 2 and No. 4.

For HSOP-6J package type, wire the following GND pins together: No. 2, No. 4, and No. 5.

R1524x

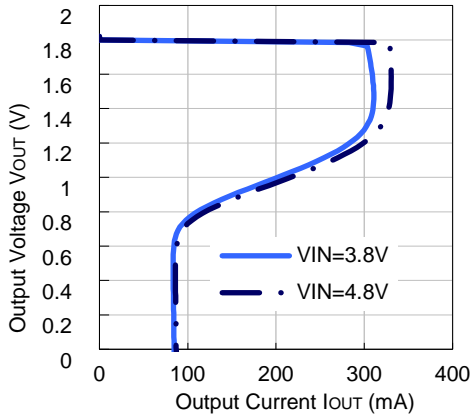
No. EC-332-190109

TYPICAL CHARACTERISTICS

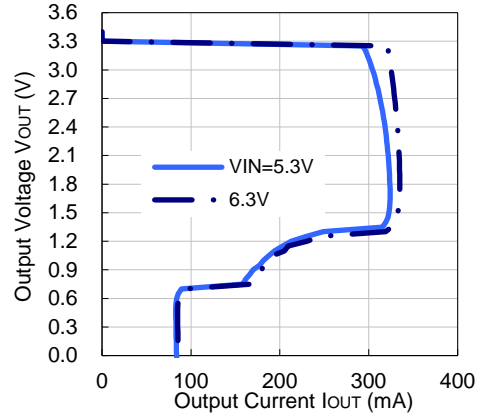
Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

1) Output Voltage vs. Output Current (Ta = 25°C)

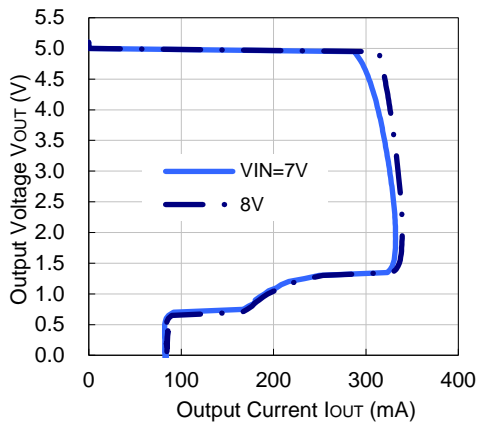
R1524x018B



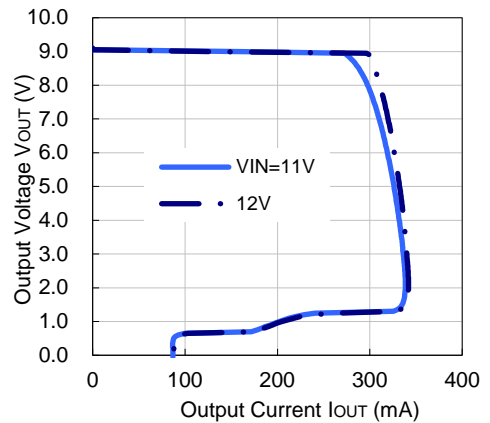
R1524x033B



R1524x050B

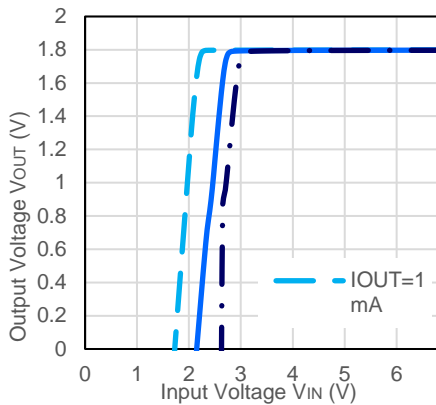


R1524x090B

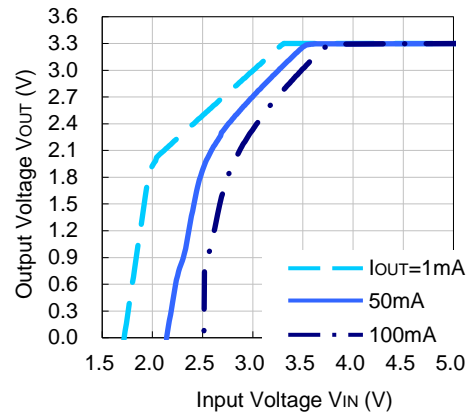


2) Output Voltage vs. Input Voltage (Ta = 25°C)

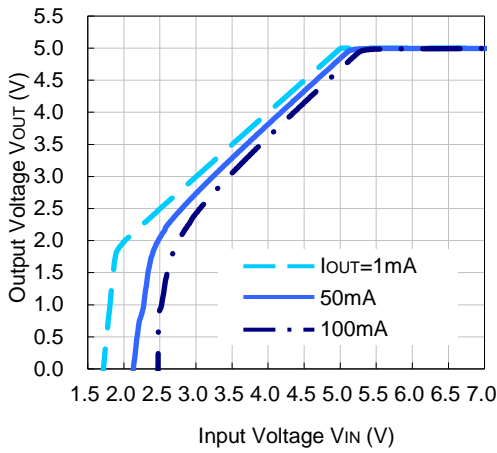
R1524x018B



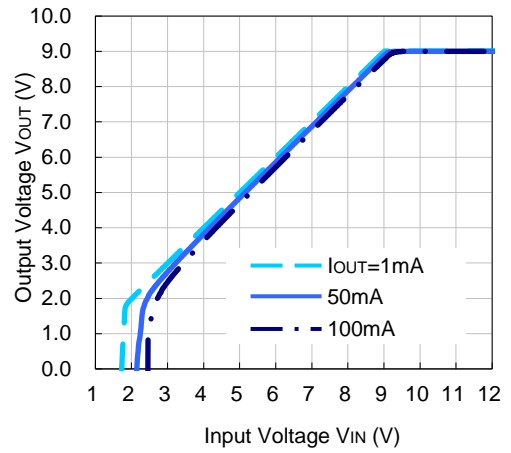
R1524x033B



R1524x050B

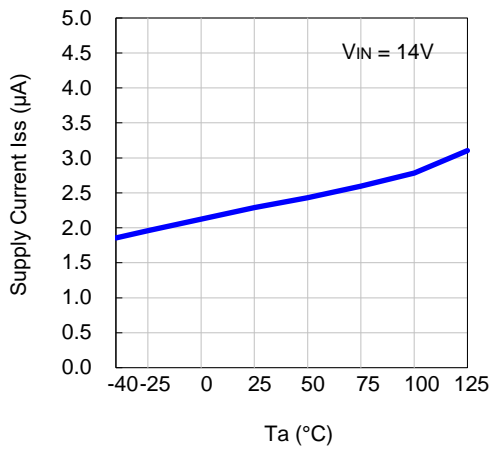


R1524x090B

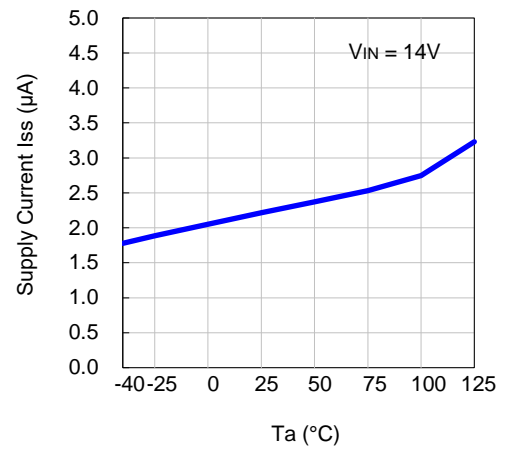


3) Supply Current vs. Temperature

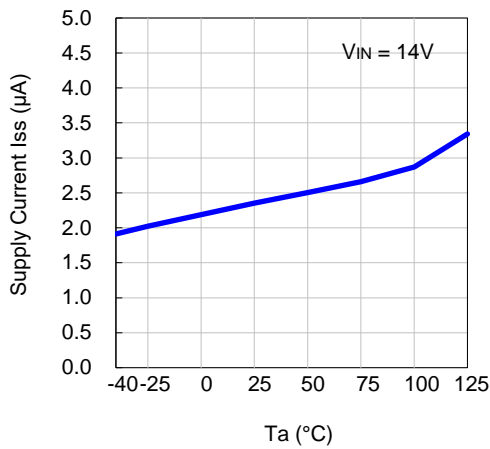
R1524x018B



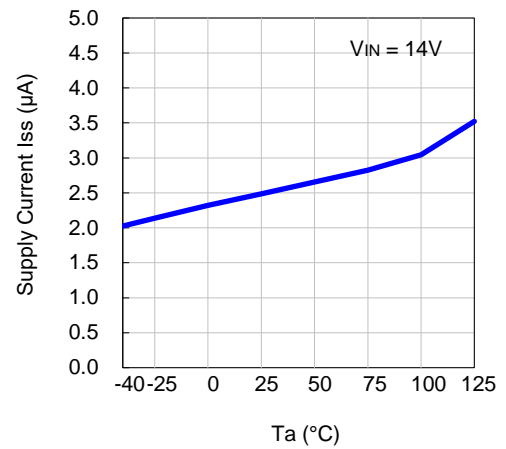
R1524x033B



R1524x050B



R1524x090B

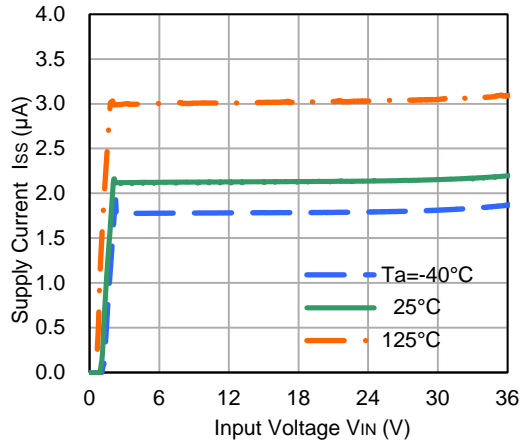


R1524x

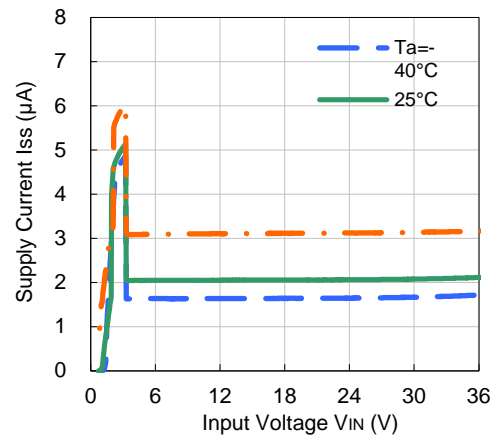
No. EC-332-190109

4) Supply Current vs. Input Voltage

R1524x018B

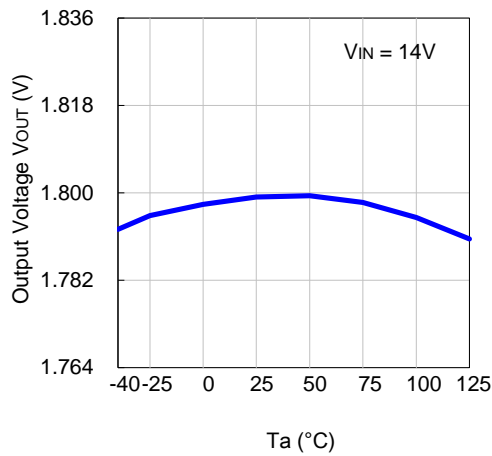


R1524x033B

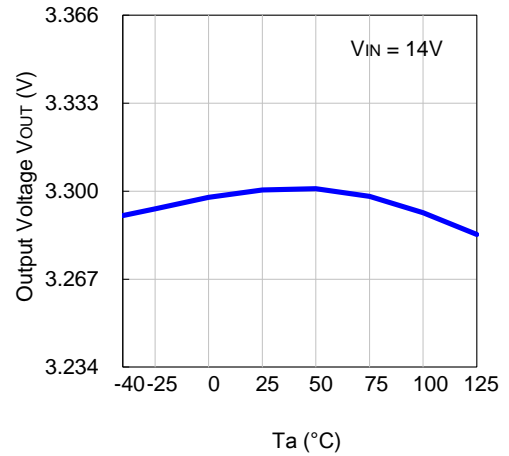


5) Output Voltage vs. Temperature ($I_{OUT} = 1mA$)

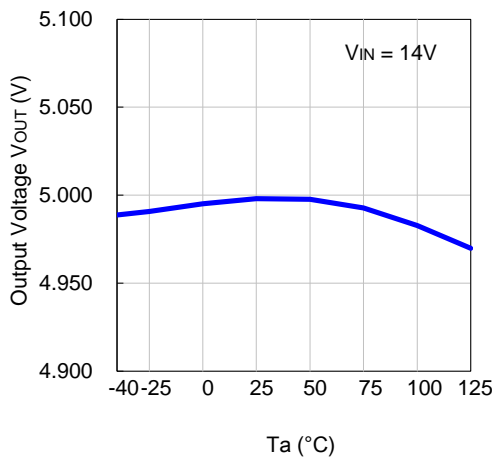
R1524x018B



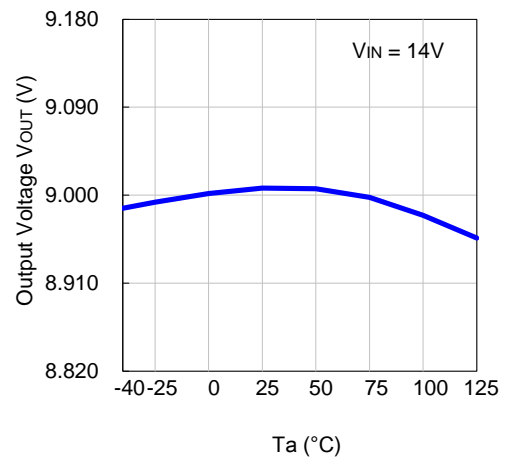
R1524x033B



R1524x050B

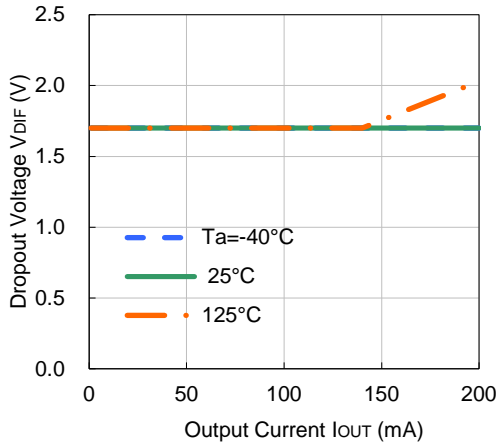


R1524x090B

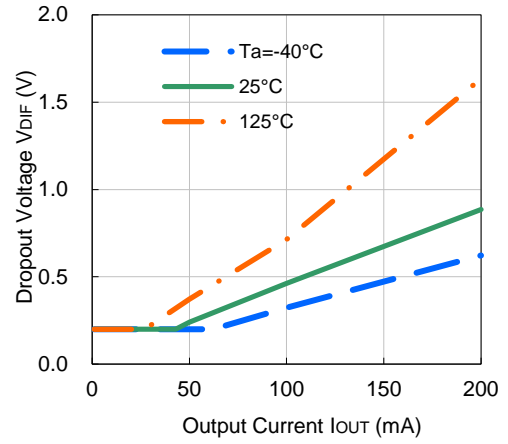


6) Dropout Voltage vs. Output Current

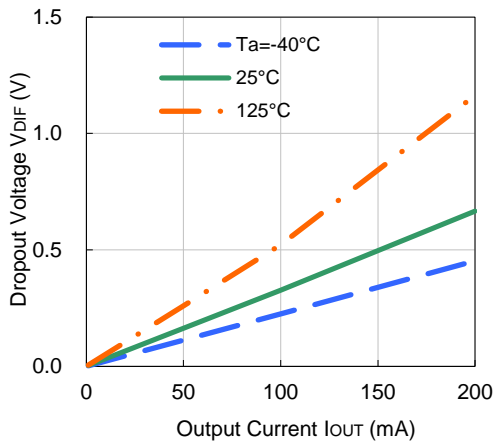
R1524x018B



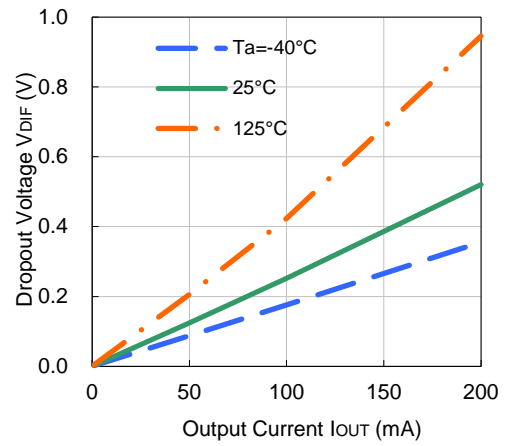
R1524x033B



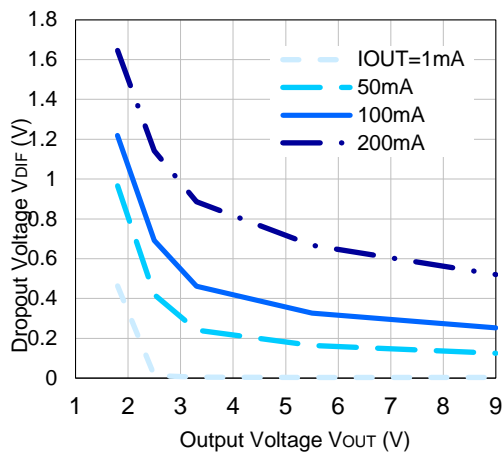
R1524x050B



R1524x090B



7) Dropout Voltage vs. Output Voltage (Ta = 25°C)

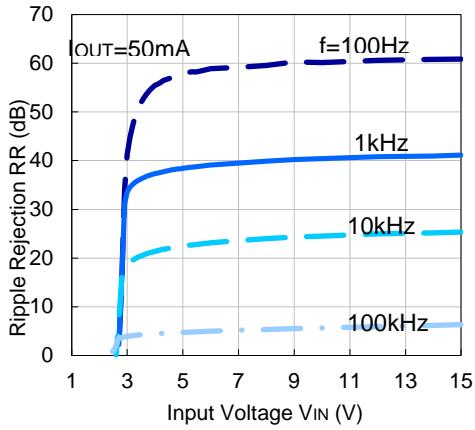


R1524x

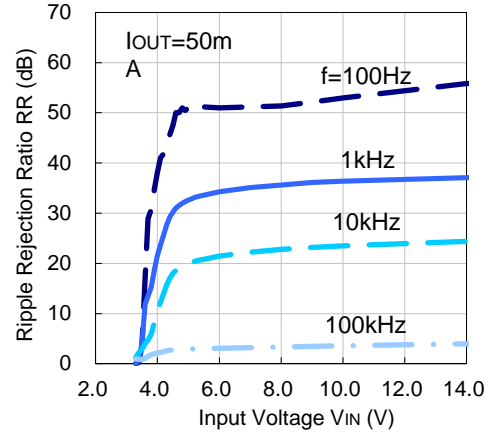
No. EC-332-190109

8) Ripple Rejection vs. Input Voltage ($T_a = 25^\circ\text{C}$, Ripple = 0.2 Vpp)

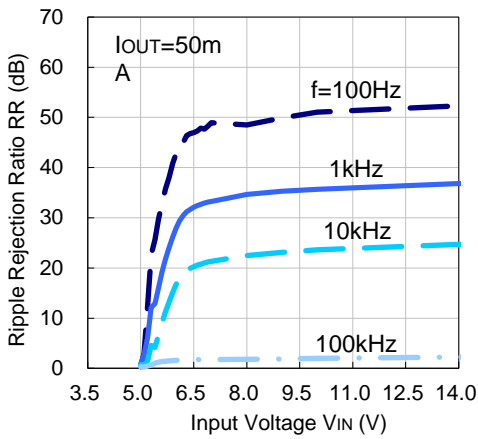
R1524x018B



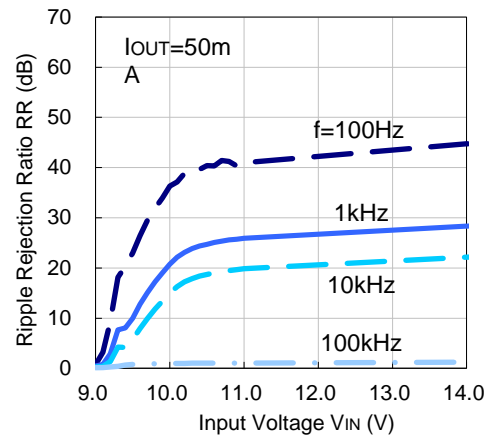
R1524x033B



R1524x050B

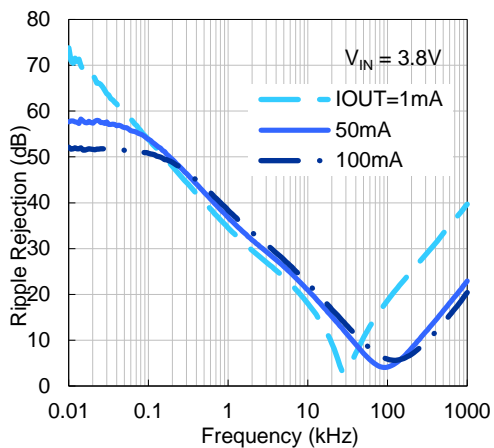


R1524x090B

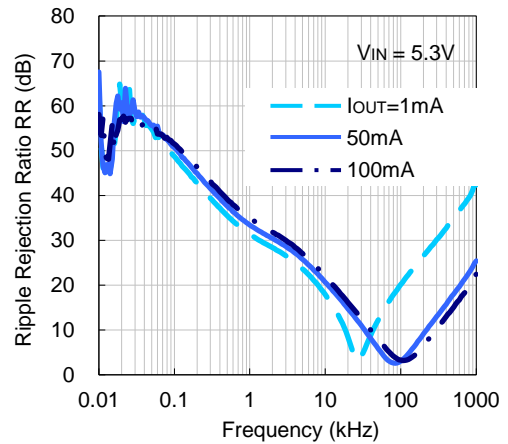


9) Ripple Rejection vs. Frequency ($T_a = 25^\circ\text{C}$, Ripple = 0.2 Vpp)

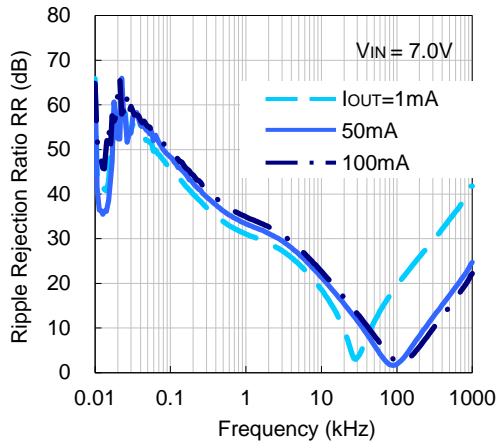
R1524x018B



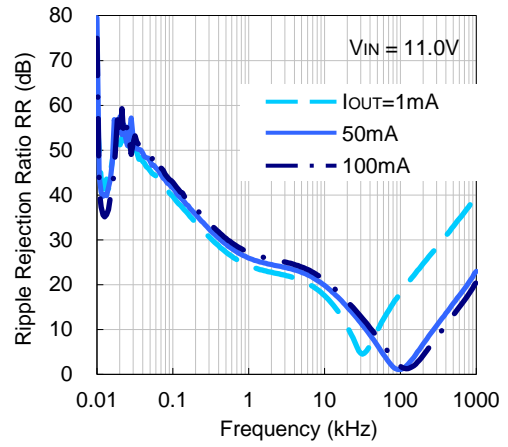
R1524x033B



R1524x050B

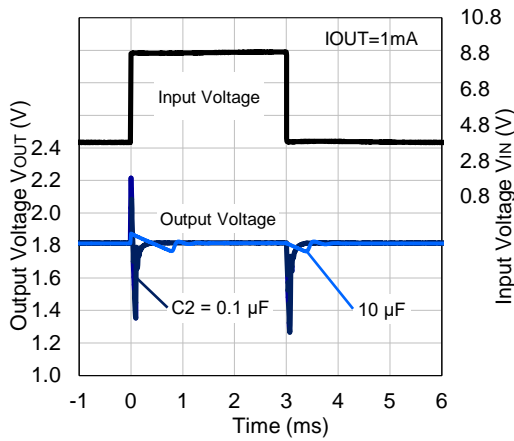


R1524x090B

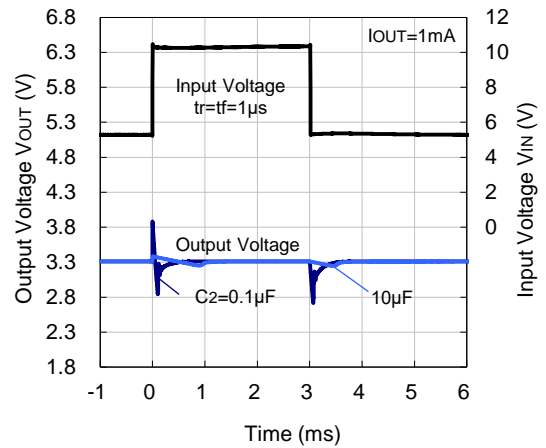


10) Input Transient Response ($T_a = 25^\circ C$)

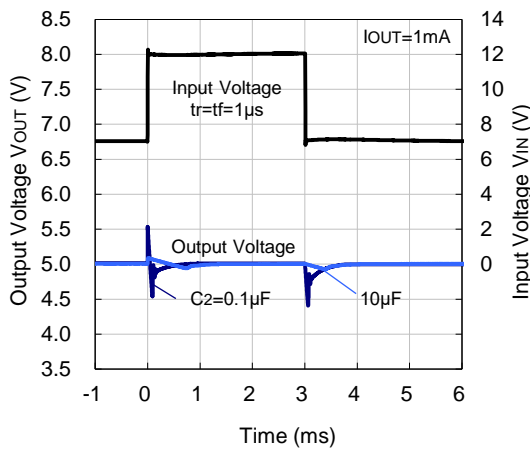
R1524x018B



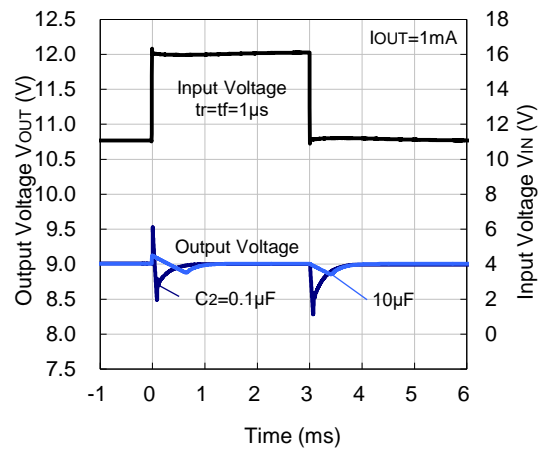
R1524x033B



R1524x050B



R1524x090B

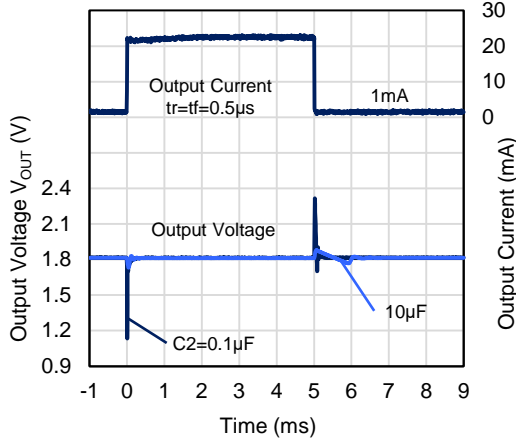


R1524x

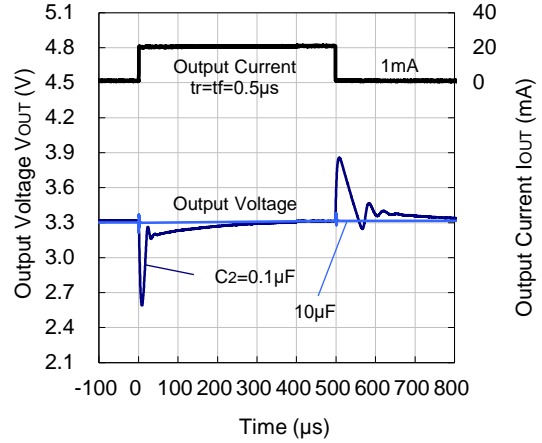
No. EC-332-190109

11) Load Transient Response (Ta = 25°C)

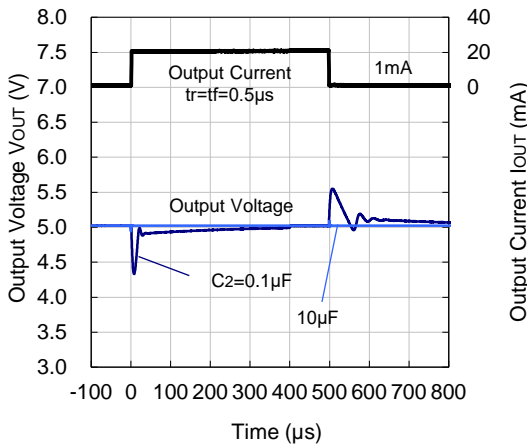
R1524x018B



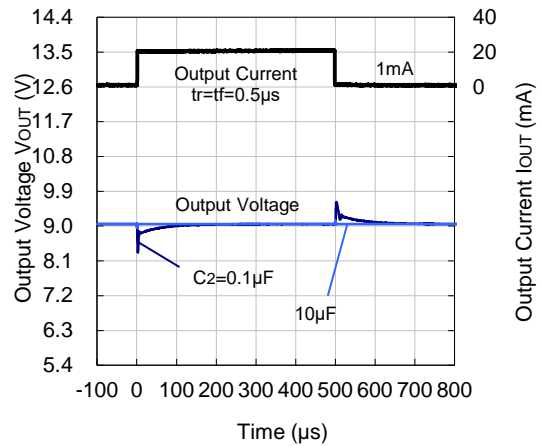
R1524x033B



R1524x050B

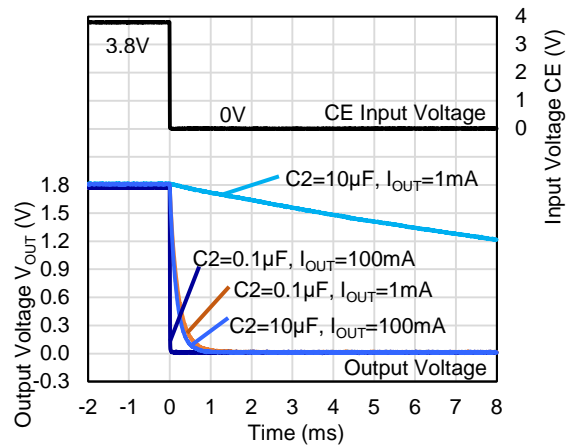
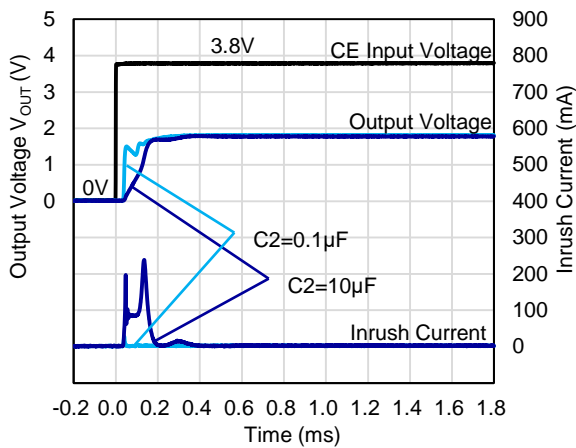


R1524x090B

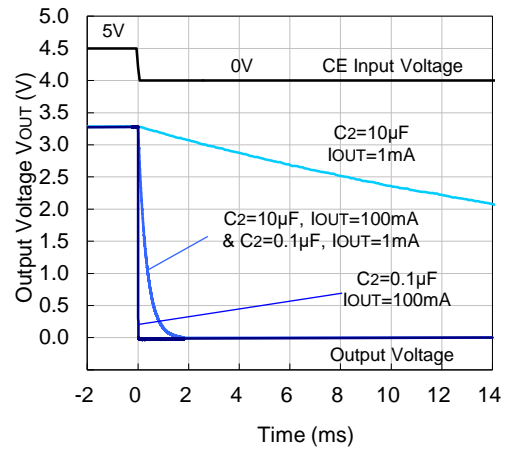
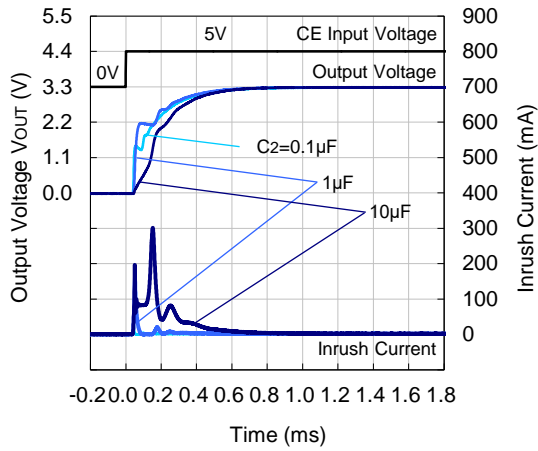


12) CE Transient Response (Ta = 25°C)

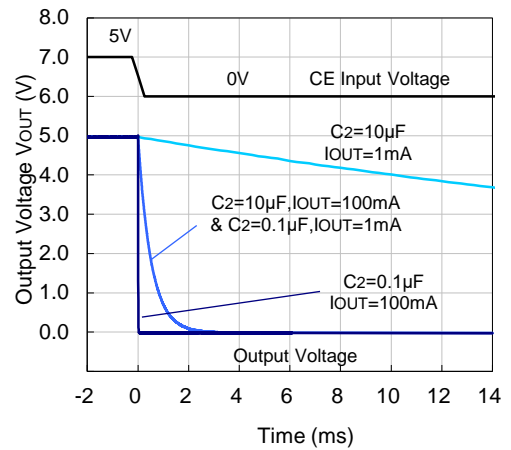
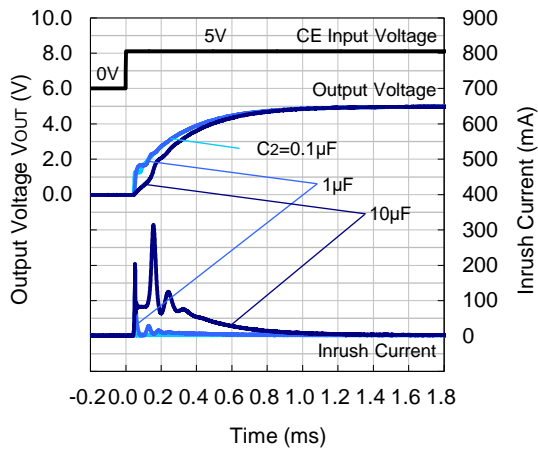
R1524x018B



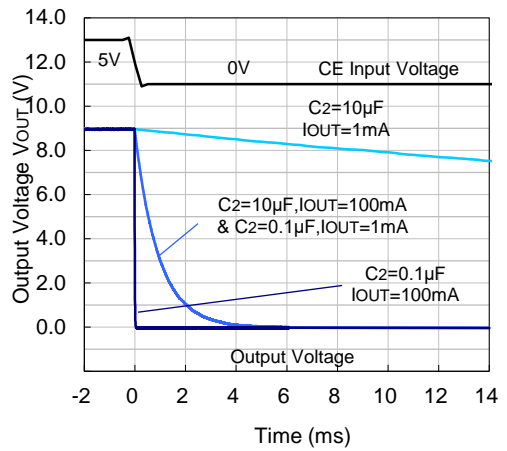
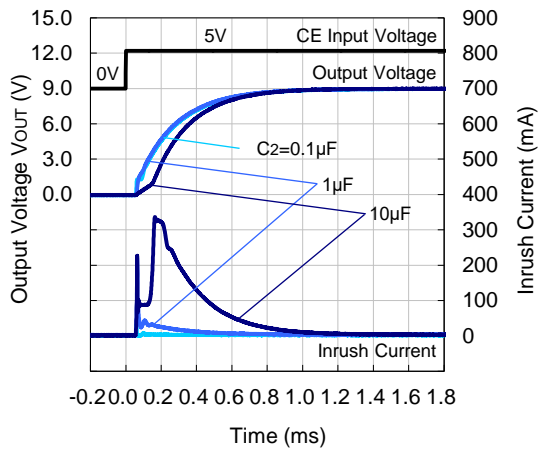
R1524x033B



R1524x050B



R1524x090B

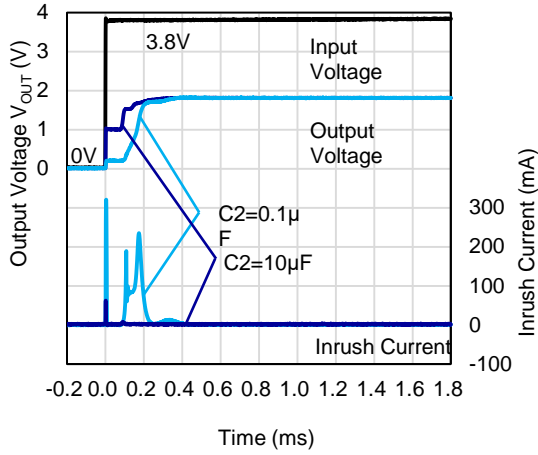


R1524x

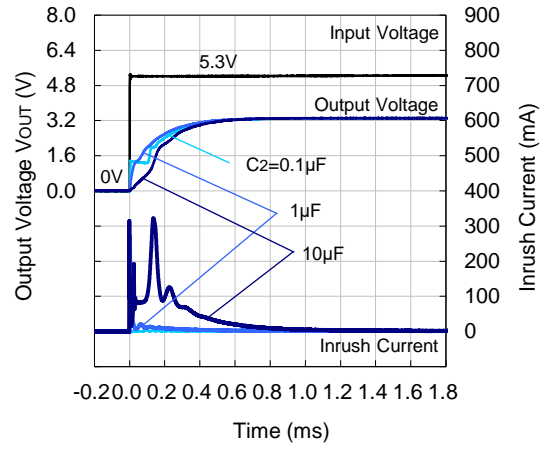
No. EC-332-190109

13) Power-on Transient Response ($T_a = 25^\circ\text{C}$, $V_{CE} = 5\text{ V}$)

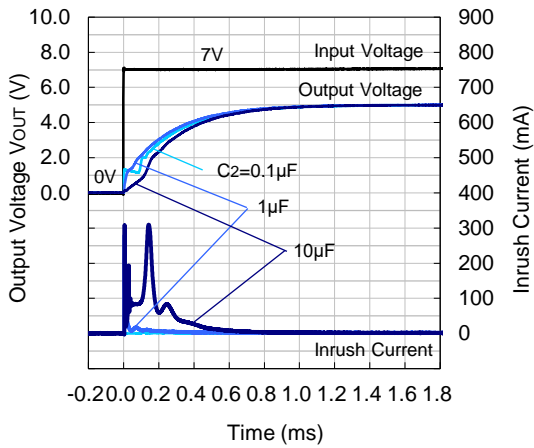
R1524x018B



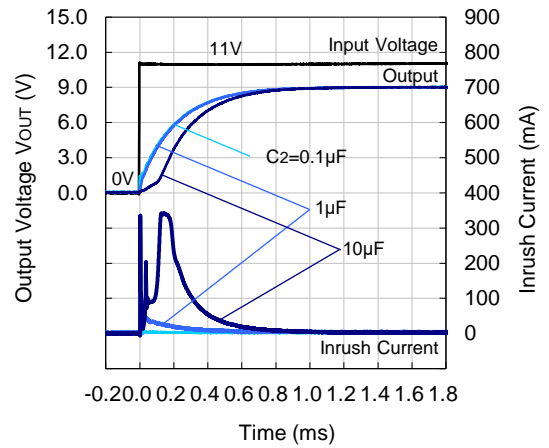
R1524x033B



R1524x050B

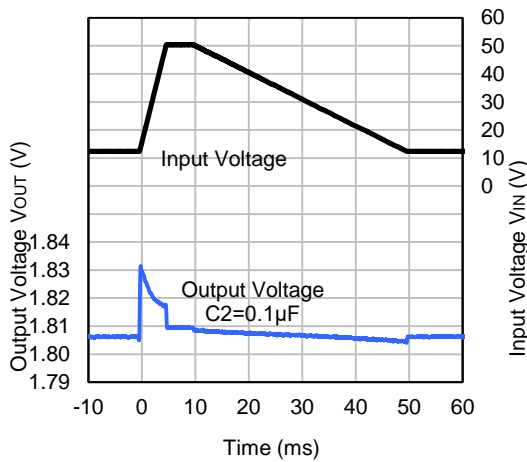


R1524x090B

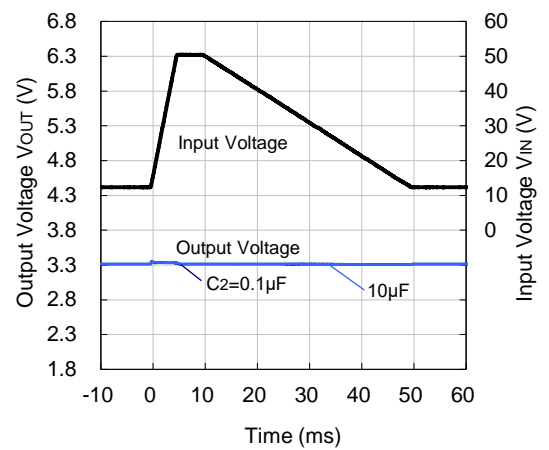


14) Load Dump ($T_a = 25^\circ\text{C}$)

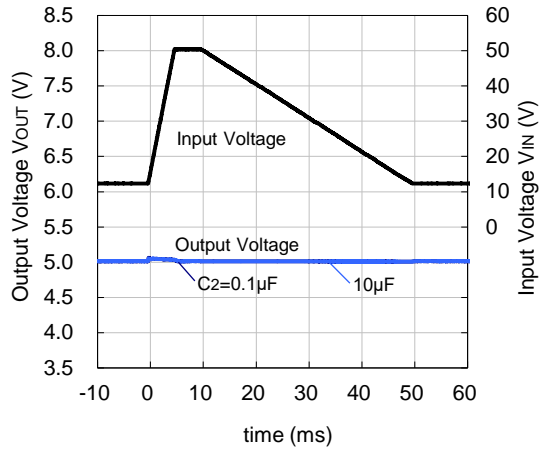
R1524x018B



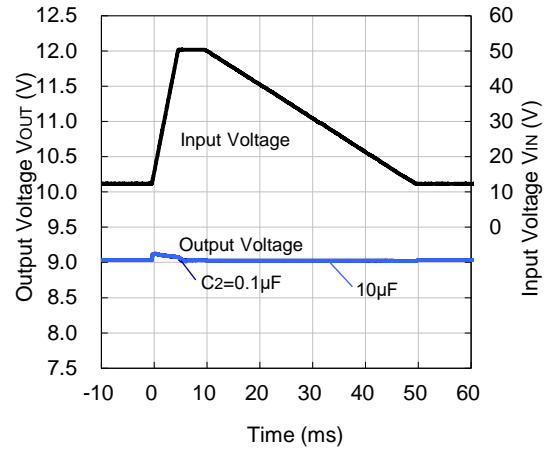
R1524x033B



R1524x050B

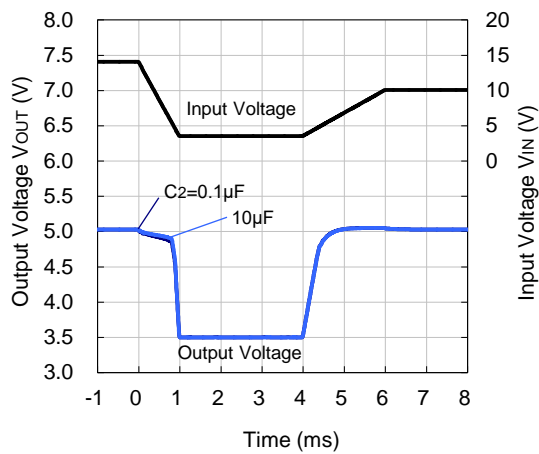


R1524x090B

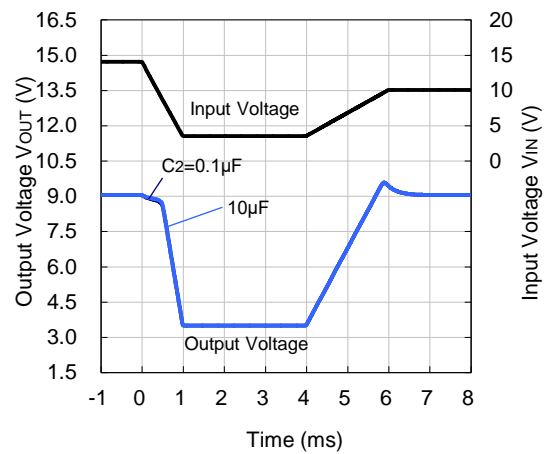


15) Cranking (Ta = 25°C)

R1524x050B



R1524x090B



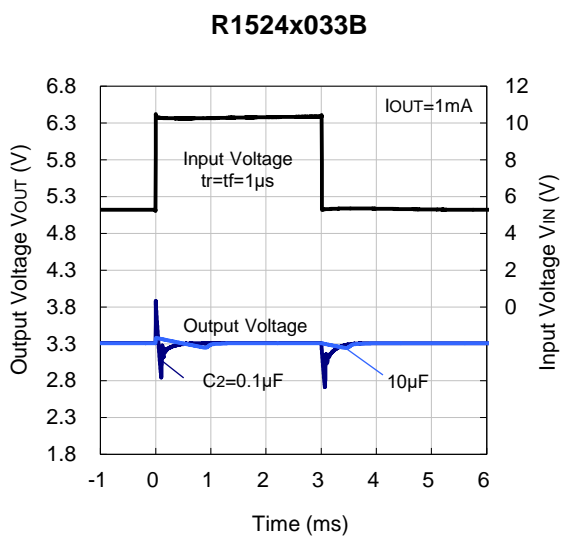
R1524x

No. EC-332-190109

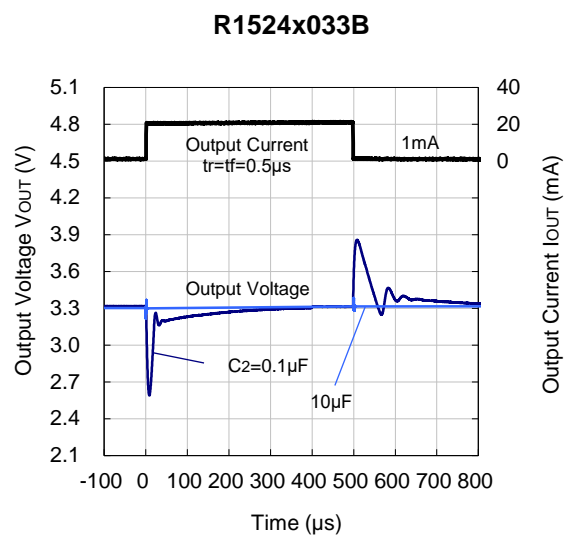
Input Transient/Load Transient vs. Output Capacity (C2)

R1524 performs a stable operation by using 0.1 μF of ceramic capacitor as the output capacitor. However, the variation of output voltage may not meet the demand of the system when input voltage and load current vary. In such cases, the variation of output voltage can be minimized significantly by using 10 μF or higher ceramic capacitor. When using an electrolytic capacitor for the output line, place the electrolytic capacitor outer side of the ceramic capacitor arranged close to the IC.

Input Transient Response

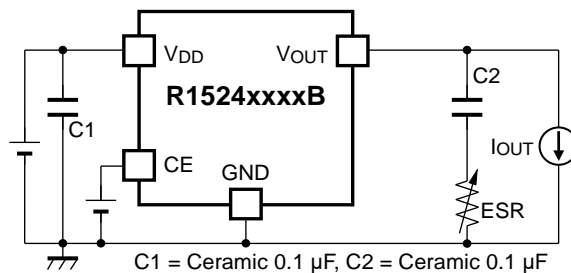


Load Transient Response



ESR vs. Output Current

It is recommended that a ceramic type capacitor be used for this device. However, other types of capacitors having lower ESR can also be used. The relation between the output current (I_{OUT}) and the ESR of output capacitor is shown below.



Measurement Conditions

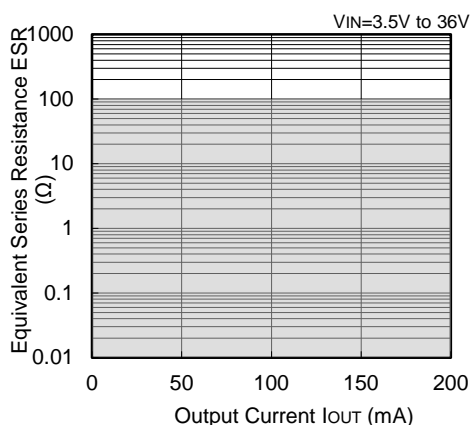
Frequency Band: 10 Hz to 2 MHz

Measurement Temperature: -40°C to 125°C

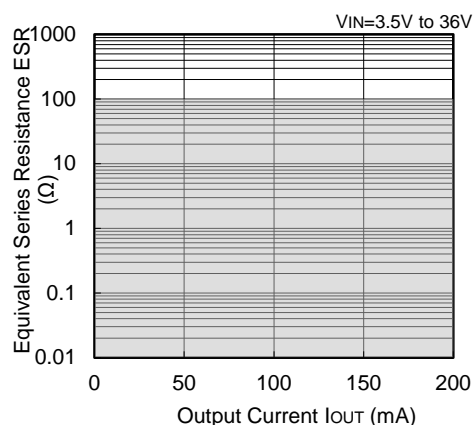
Hatched area: Noise level is 40 μ V (average) or below

Ceramic Capacitors: C1 = 0.1 μ F, C2 = 0.1 μ F

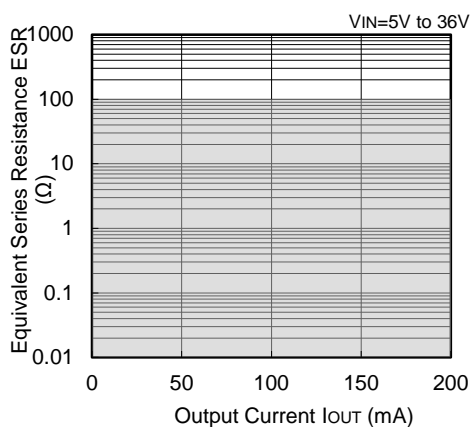
R1524x018B



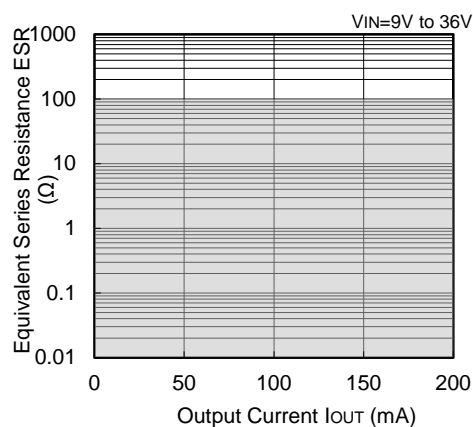
R1524x033B



R1524x050B



R1524x090B



The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 7 pcs

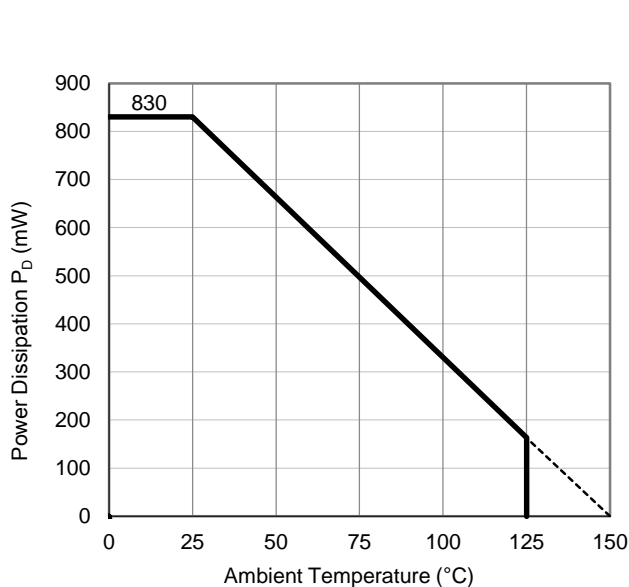
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

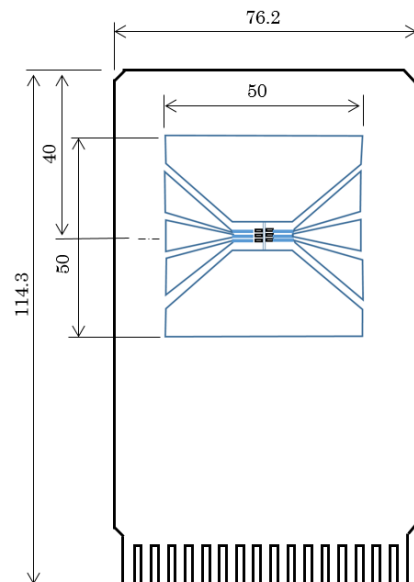
Item	Measurement Result
Power Dissipation	830 mW
Thermal Resistance (θja)	θja = 150°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W

θja: Junction-to-Ambient Thermal Resistance

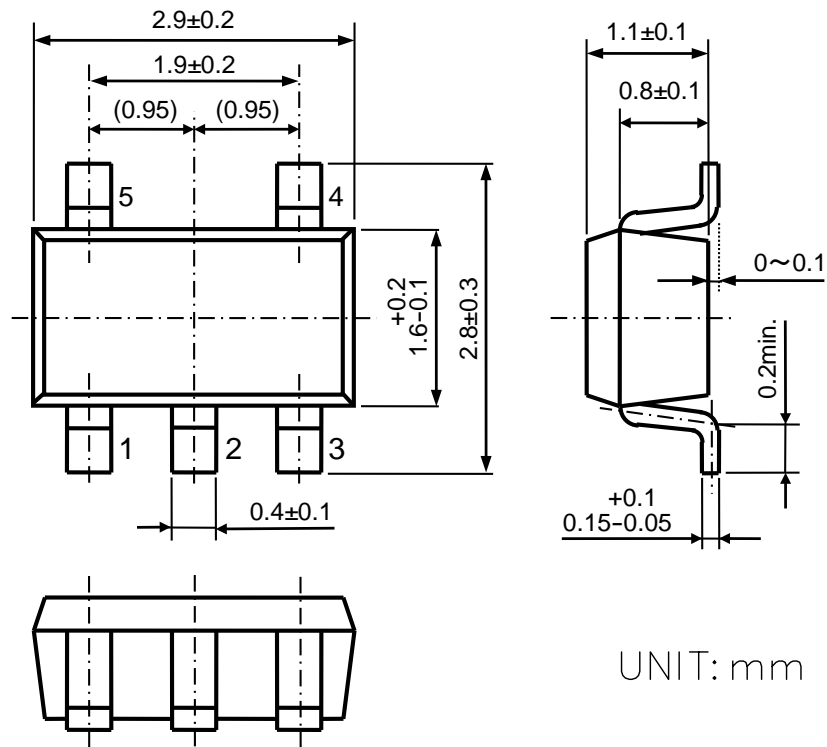
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



UNIT: mm

SOT-23-5 Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 13 pcs

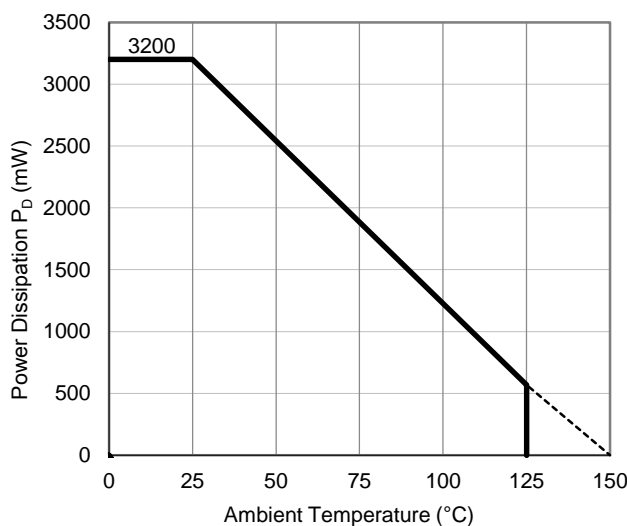
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

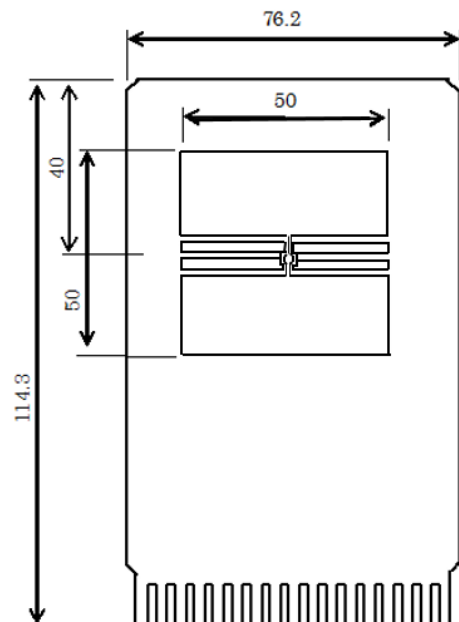
Item	Measurement Result
Power Dissipation	3200 mW
Thermal Resistance (θja)	θja = 38°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 13°C/W

θja: Junction-to-Ambient Thermal Resistance

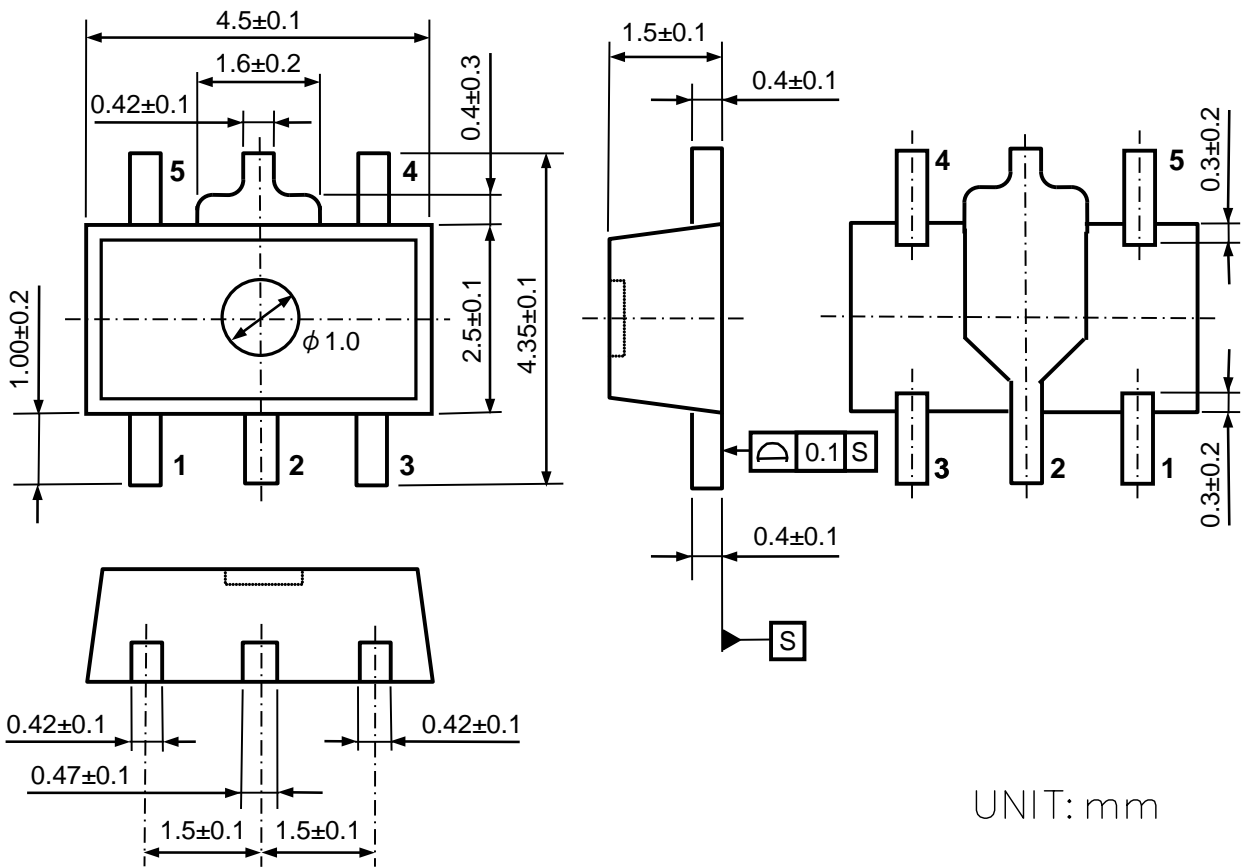
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



UNIT: mm

SOT-89-5 Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 28 pcs

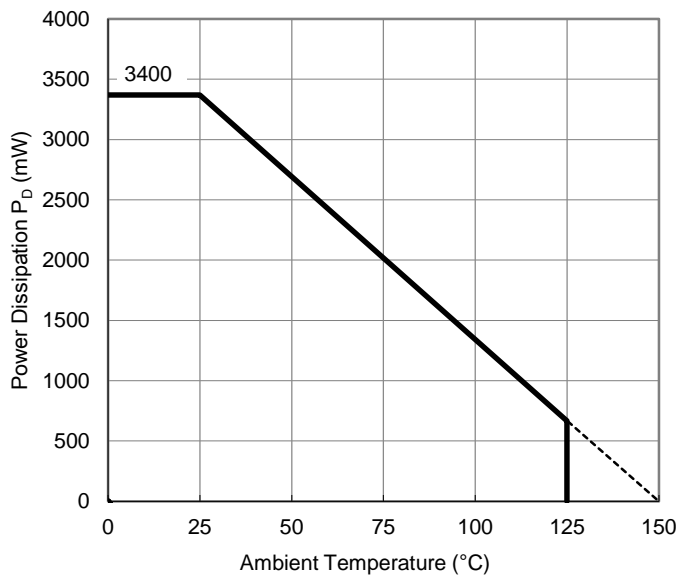
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

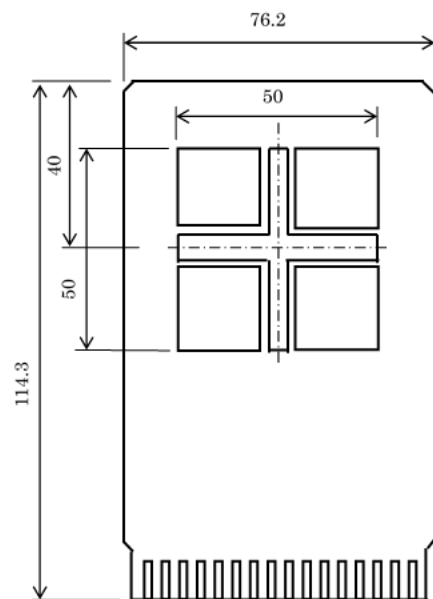
Item	Measurement Result
Power Dissipation	3400 mW
Thermal Resistance (θ_{ja})	$\theta_{ja} = 37^{\circ}\text{C/W}$
Thermal Characterization Parameter (ψ_{jt})	$\psi_{jt} = 7^{\circ}\text{C/W}$

θ_{ja} : Junction-to-Ambient Thermal Resistance

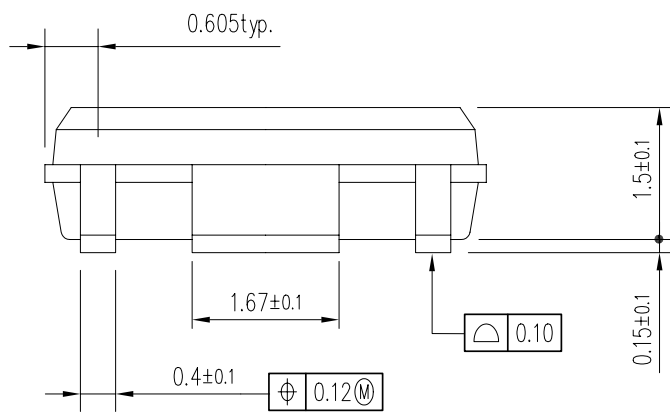
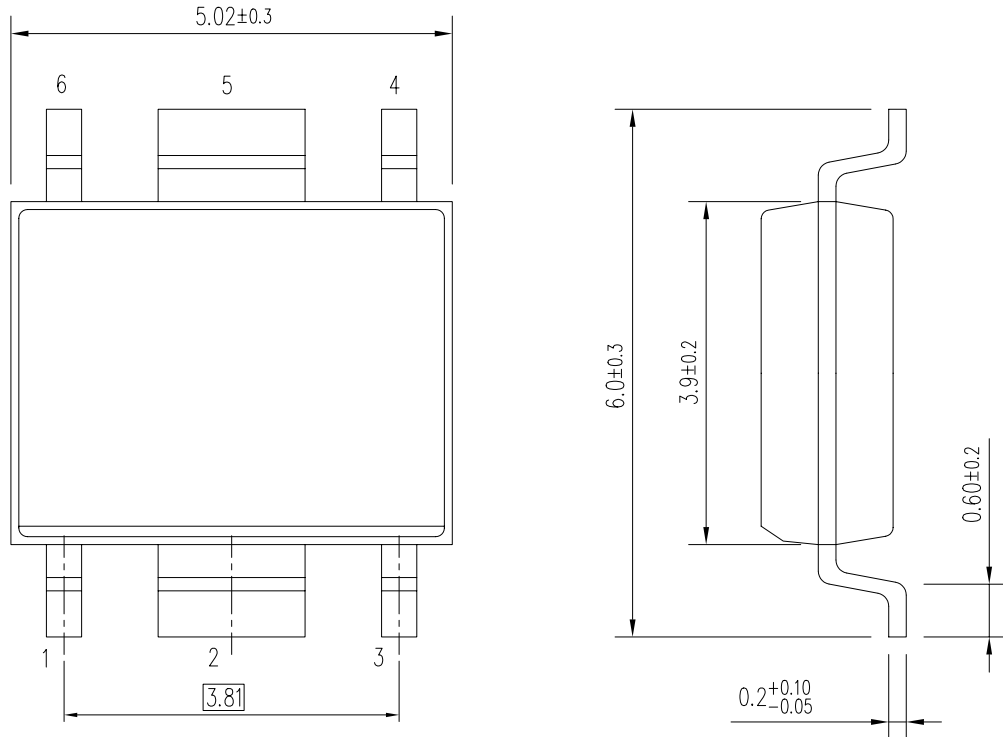
ψ_{jt} : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



UNIT: mm

HSOP-6J Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 21 pcs

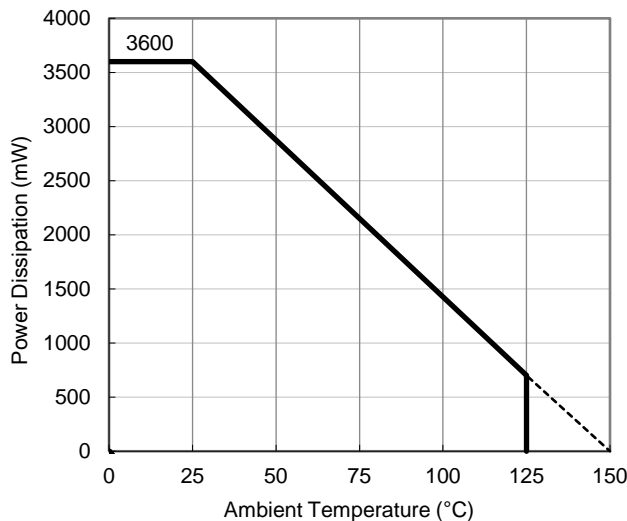
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

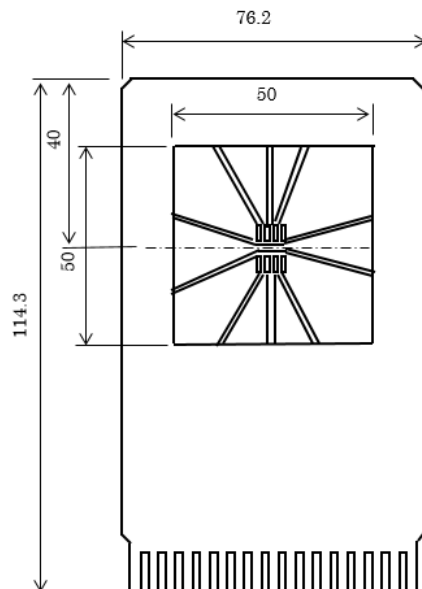
Item	Measurement Result
Power Dissipation	3600 mW
Thermal Resistance (θja)	θja = 34.5°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 10°C/W

θja: Junction-to-Ambient Thermal Resistance

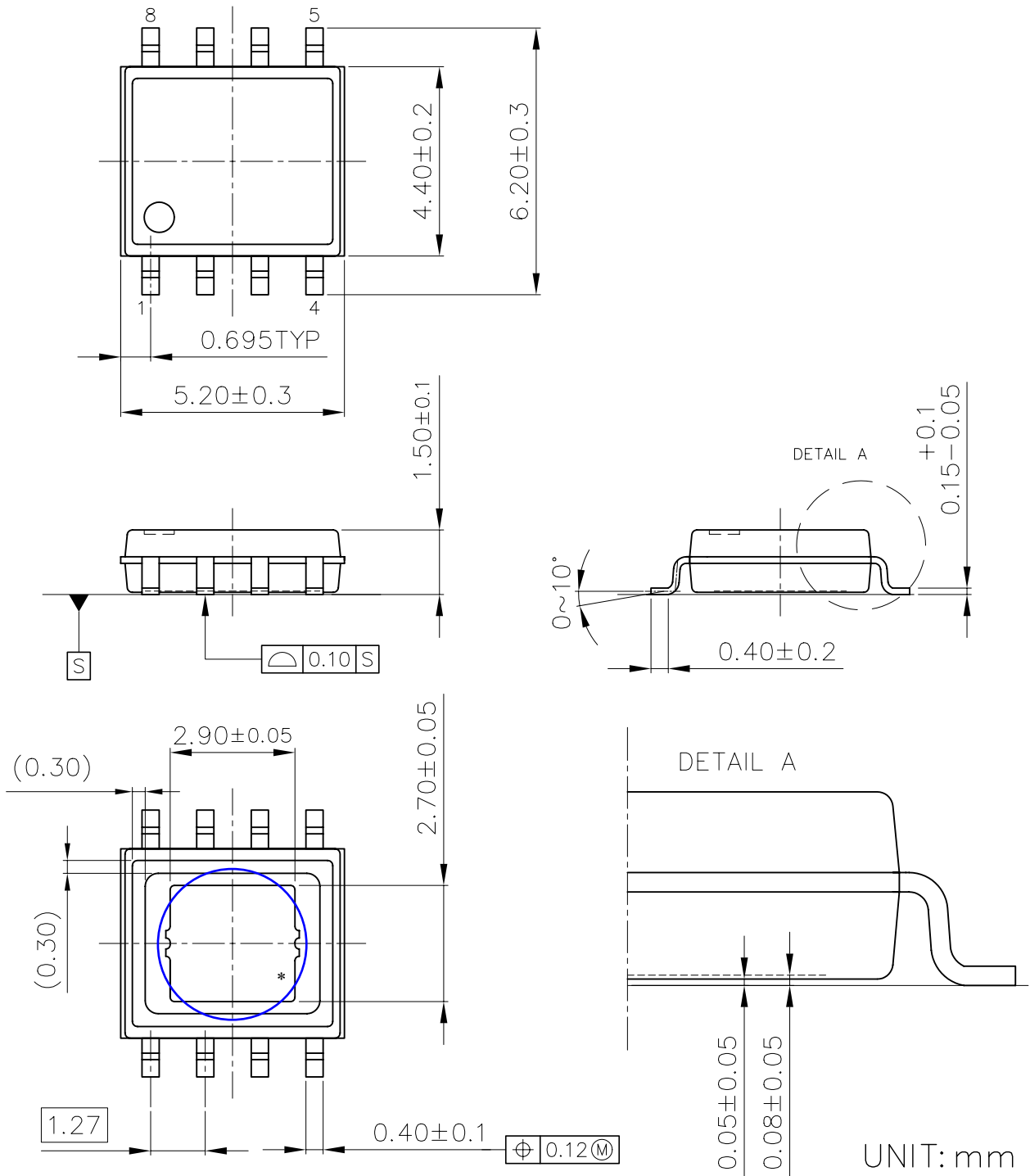
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



HSOP-8E Package Dimensions

* The tab on the bottom of the package shown by blue circle is substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.



1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to Ricoh sales representatives for the latest information thereon.
2. The materials in this document may not be copied or otherwise reproduced in whole or in part without prior written consent of Ricoh.
3. Please be sure to take any necessary formalities under relevant laws or regulations before exporting or otherwise taking out of your country the products or the technical information described herein.
4. The technical information described in this document shows typical characteristics of and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under Ricoh's or any third party's intellectual property rights or any other rights.
5. The products in this document are designed for automotive applications. However, when using the products for automotive applications, please make sure to contact Ricoh sales representative in advance due to confirming the quality level.
6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. Anti-radiation design is not implemented in the products described in this document.
8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used.
In the case of recognizing the marking characteristic with AOI, please contact Ricoh sales or our distributor before attempting to use AOI.
11. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.



Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment.

Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

RICOH RICOH ELECTRONIC DEVICES CO., LTD.

<https://www.e-devices.ricoh.co.jp/en/>

Sales & Support Offices

Ricoh Electronic Devices Co., Ltd.

Shin-Yokohama Office (International Sales)

2-3, Shin-Yokohama 3-chome, Kohoku-ku, Yokohama-shi, Kanagawa, 222-8530, Japan
Phone: +81-50-3814-7687 Fax: +81-45-474-0074

Ricoh Americas Holdings, Inc.

675 Campbell Technology Parkway, Suite 200 Campbell, CA 95008, U.S.A.
Phone: +1-408-610-3105

Ricoh Europe (Netherlands) B.V.

Semiconductor Support Centre

Prof. W.H. Keesomlaan 1, 1183 DJ Amstelveen, The Netherlands
Phone: +31-20-5474-309

Ricoh International B.V. - German Branch

Semiconductor Sales and Support Centre

Oberrather Strasse 6, 40472 Düsseldorf, Germany
Phone: +49-211-6546-0

Ricoh Electronic Devices Korea Co., Ltd.

3F, Haesung Bldg, 504, Teheran-ro, Gangnam-gu, Seoul, 135-725, Korea
Phone: +82-2-2135-5700 Fax: +82-2-2051-5713

Ricoh Electronic Devices Shanghai Co., Ltd.

Room 403, No.2 Building, No.690 Bibo Road, Pu Dong New District, Shanghai 201203,
People's Republic of China
Phone: +86-21-5027-3200 Fax: +86-21-5027-3299

Ricoh Electronic Devices Shanghai Co., Ltd. Shenzhen Branch

1205, Block D (Jinlong Building), Kingkey 100, Hongbao Road, Luohu District,
Shenzhen, China
Phone: +86-755-8348-7600 Ext 225

Ricoh Electronic Devices Co., Ltd.

Taipei office

Room 109, 10F-1, No.51, Hengyang Rd., Taipei City, Taiwan
Phone: +886-2-2313-1621/1622 Fax: +886-2-2313-1623

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Ricoh Electronics:

[R1580N002A-TR-YE](#) [R1524S050H-E2-KE](#) [R1524S090B-E2-KE](#) [R1524N090B-TR-KE](#) [R1524H090B-T1-KE](#)
[R1524S033H-E2-KE](#) [R1524S080B-E2-KE](#) [R3116K291A-TR-Y](#) [R3116K311A-TR-Y](#) [R3152N014A-TR-KE](#)
[R3152N017A-TR-KE](#) [R3160N150A-TR-KE](#)